Enterprise NVMe SSD Series

Warranty Statement



DapuStor

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1 Warranty Statement

DapuStor Corporation (hereinafter referred to as "DapuStor" in short) warrants to the purchasers (hereinafter referred to as "You" in short) of the DapuStor Enterprise NVMe SSD Series Products (hereinafter referred to as "the product" in short) with original sealed package as following: under the premise that you correctly install and use the product, there will be no obvious defects in materials and manufacturing process, from the date that you sign for the product with the original sealed package to the date that comes earlier between the following two cases:

- (a) from the date that you sign for the product with the original sealed package to the expiration date of the five-year warranty period;
- (b) from the date that you sign for the product with the original sealed package to the date that the "Percentage Used Estimated" measured by standard NVMe-Cli tool has reached or exceeded 100%, or, from the date that you sign for the product with the original sealed package to the date that the product has reached or exceeded its TBW (Total Bytes Written) threshold. You can refer to the data of the product data sheet at www.dapustor.com to calculate the TBW.

If the product fails to meet the above warranty terms after DapuStor's confirmation, DapuStor will based on factors such as the nature of the fault and inventory availability, reasonably select one of the following remedial measures:

- (a) repair the hardware and/or update the software of the product;
- (b) replace the product with another new or refurbished product of the same capacity;
- (c) If DapuStor is unable to repair or replace this product, a discounted refund will be processed based on the remaining warranty period of this product at the time you submit a warranty

service request to DapuStor.

Due to the repair or replace, before you send the product that store data to DapuStor, please ensure that you has backed up the data, and you has deleted the confidential, proprietary or personal information, etc., DapuStor will not assume any responsibility for data security.

Inapplicable cases of the warranty are as following:

- (a) Failure to use this product in accordance with the product instructions or DapuStor instructions or user guides, etc.;
- (b) Use this product in environments beyond the product's operating temperature range, strong magnetic fields, strong radiation, high humidity, non neutral, or corrosive
- (c) Any failure or defect resulted from the use of any third party's product, software or component;
- (d) Any faults or defects caused by external factors such as improper installation, incorrect use, unauthorized maintenance by DapuStor, personal reasons (physical damage caused by improper storage, operational negligence, improper testing, etc.), disasters (such as fires, floods, earthquakes), accidents, etc;
- (e) Any costs incurred in the upgrading, repairing or replacing of the product, including but not limited to: installation costs, unloading costs, labor costs and other related expenses;
- (f) other failure not caused by DapuStor, failure caused not using original parts, failure caused by incompatibility with third-party software or hardware;
- (g) The use of the product reaches its write endurance limit, such as TBD as described above.
- (h) Physical damage to the surface of the equipment that does not affect its operation;

DapuStor shall not be liable for any loss of data (including loss, deletion, corruption or tampering) resulting from any failure of the product, whatever the reason is. Furthermore, you agrees to keep a certified backup of all data on this product to prevent data loss.

Any and all disputes arising under or related to this Warranty Statement shall be governed by the laws of the People's Republic of China. The final interpretation of this document belongs to

DapuStor Corporation

2 Environmental Protection Support

The product conforms to the EU RoHS2.0 (2011/65/EU) Environmental Protection Standard, please refers to the table below:

David Manage	Hazardous Substance or Element									
Part Name	Pb	Hg	Cd	Cr6+	PBB	PBDE	DEHP	BBP	DBP	DIBP
Component	0	0	0	0	0	0	0	0	0	0
PCB	0	0	0	0	0	0	0	0	0	0
Solder Paste	0	0	0	0	0	0	0	0	0	0
Passive & Active Device	0	0	0	0	0	0	0	0	0	0
	"O" represents that the concentration of the hazardous substance or element in									
Note:	all homogeneous materials in the part meets the standard requirement of the									
	revision instruction 2011/65/EU of the EU ROHS instruction 2015/863.									

3 Certification Information

Certification	Organization/	Description	
Item	Country	Description	
FCC	America	Caution: Any changes or modifications not expressly approved by the party responsible for compliance could void the users' authority to operate the equipment.	
CE	Europe	Hereby, DapuStor declares that the product is in compliance with the essential requirements and relevant provisions of the RED Directive 2014/53/EU.	

If you have any question, please call 400-9938-968. We will solve it for you at the first time.



www.dapustor.com

DapuStor Corporation

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Appendix - Limited Warranty Specification

The specified value for the comprehensive temperature of the DapuStor enterprise-level NVMe SSD series product's SMART information.

Product	Warranty Temperature Limit	Reported by	Commands Used
Haishen3 Series eSSD AIC, U.2	Sensor0 348K (75°C); Sensor1 373K (100°C); Sensor2-5 average 348K (75°C)	Log Page Identifier: Log ID=0xCA,Byte [7:6],[1:0] "HighestTemperature Kelvin" Equaling or Exceeding 358K; Log ID=0xCA,Byte [15:14], "HighestTemperatur e Kelvin" Equaling or Exceeding 393K	Linux: nvme get-log /dev/nvme0n1-i 0xca -l 64-s 1 or nvme dapu get-selfDefineSmartInfo /dev/nvme0 -H
Haishen3-XL Series eSSD AIC, U.2	Sensor0 348K (75°C); Sensor1 373K (100°C); Sensor2-5 average 348K (75°C).	Log Page Identifier: Log ID=0xCA,Byte [7:6],[1:0] "HighestTemperatur e Kelvin" Equaling or Exceeding 358K; Log ID=0xCA,Byte [15:14], "Highest Temperature Kelvin" Equaling or Exceeding 393K	Linux: nvme get-log /dev/nvme0n1 -i 0xca -l 64 -s 1 or nvme dapu get-selfDefineSmartInfo /dev/nvme0 -H

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Roealsen5 Series eSSD AIC, U.2	Composite Temperature 351K (78°C); Sensor1 373K (100°C); Sensor2-5 351K (78°C).	Log Page Identifier: Log ID=0xCA,Byte [7:6],[1:0] "Highest Temperature Kelvin" Equaling or Exceeding 358K; Log ID=0xCA,Byte [15:14], "Highest Temperature Kelvin" Equaling or Exceeding 393K	Linux: nvme get-log /dev/nvme8n1 -i 0xca -l 1128 -s 1
Xlenstor2 Series eSSD U.2	Composite Temperature 351K (78°C); Sensor1 373K (100°C); Sensor2-5 351K (78°C).	Log Page Identifier: Log ID=0xCA,Byte [7:6],[1:0] "Highest Temperature Kelvin" Equaling or Exceeding 358K; Log ID=0xCA,Byte [15:14], "Highest Temperature Kelvin" Equaling or Exceeding 393K	Linux: nvme get-log /dev/nvme8n1 -i 0xca -l 1128 -s 1

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Jiaorong5 Series eSSD AIC, U.2 Roealsen6 Series eSSD	Composite Temperature 351K (78°C); Sensor1 373K (100°C); Sensor2-5 351K (78°C). Composite Temperature 350K (77°C)	Log Page Identifier: Log ID=0xCA,Byte [7:6],[1:0] "Highest Temperature Kelvin" Equaling or Exceeding 358K; Log ID=0xCA,Byte [15:14], "Highest Temperature Kelvin" Equaling or Exceeding 393K Log Page Identifier: Log ID=0xC3, Byte	Linux: nvme get-log /dev/nvme8n1 -i 0xca -l 1128 -s 1 Linux: nvme get-log /dev/nvme0n1
Series eSSD E3.S ,U.2		Log ID=0xC3, Byte [1:0] "Flash Highest Temperature Kelvin" Equaling or Exceeding 350K; Log ID=0xC3, Byte [15:14] " Controller Highest Temperature Kelvin" Equaling or Exceeding 373K	nvme get-log /dev/nvme0n1 -i 0xc3 -l 256 -s 1
Haishen 5	, in the second	Log Page Identifier:	Linux:
Series eSSD		Log ID=0xC3, Byte [1:0]"Flash Highest	Nvme get-log
E1.S,E3.S,U.2	Sensor1 373K(100°C);	Temperature Kelvin'Equaling or	/dev/nvme0n1 -i 0xc3 -256-s

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Sensor2 358K(85°C);	Exceeding 351K;	1
Sensor3 6 351K(78°C).		
	Log ID=0xC3, Byte [7:6] "Highest	
	Temperature Kelvin'Equaling or	
	Exceeding 358K;	
	Log ID=0xC3,Byte	
	[15:14]"Controller	
	Highest	
	Temperature Kelvin"	
	Equalingor	
	Exceeding 373K	